506234406 09/02/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6281150

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SUNG HYUNG KANG	09/28/2018
YONG KOO KIM	10/10/2018
HYUNG KYU KIM	10/10/2018
WON HEE YOO	10/10/2018
JONG HYUN CHO	09/28/2018
BYUNG KIL YUN	10/01/2018
SEOK KYOON WOO	10/10/2018
HYUN SUNG DONG	10/01/2018

RECEIVING PARTY DATA

Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.	
Street Address:	MAEYOUNG-RO 150 (MAETAN-DONG), YOUNGTONG-GU	
City:	SUWON-SI, GYEONGGI-DO	
State/Country:	KOREA, REPUBLIC OF	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17010342

CORRESPONDENCE DATA

Fax Number: (202)739-3001

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2027393000

Email: wapatents@morganlewis.com, angie.ellis@morganlewis.com

Correspondent Name: MORGAN, LEWIS & BOCKIUS LLP Address Line 1: 1111 PENNSYLVANIA AVENUE, NW

Address Line 4: WASHINGTON, D.C. 20004

ATTORNEY DOCKET NUMBER:	123193-8240-US	
NAME OF SUBMITTER:	ANGELA Y. ELLIS	
SIGNATURE:	/Angela Y. Ellis/	
DATE SIGNED:	09/02/2020	

PATENT REEL: 053677 FRAME: 0254

Total Attachments: 3

source=Continuation-Declaration-Assignment#page1.tif source=Continuation-Declaration-Assignment#page2.tif

source = Continuation - Declaration - Assignment #page 3.t if

PATENT REEL: 053677 FRAME: 0255

COMBINED DECLARATION AND ASSIGNMENT FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

MULTILAYER CAPACITOR

which	application is:	
X	attached, or	
	United States application number or PCT international application number filed on	
The ab	ove-identified application was made or authorized to be made by me.	
In the event that the filing date and/or application number are not entered above at the time I execute this document, and if such information is deemed necessary, I hereby authorize and request the registered practitioners of McDermott Will & Emery LLP, associated with the Customer Number 20277, to insert above the filing date and/or application number of the application.		
I hereby acknowledge that any willful false statement made in this declaration is punishable		

under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Page 1 of 3

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

SAMSUNG ELECTRO-MECHANICS CO., LTD.

having an address at Macyoung-Ro 150 (Mactan-Dong), Youngtong-Gu, Suwon-Si, Gyeonggi-Do, Republic of Kores

hereinafter designated as the Assignee, the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignce without further or other compensation than that above set forth;

I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.

Page 2 of 3

Legal name of first inventor		
Sung Hyung KANG		
First inventor's signature	Date	
\mathcal{L}/AAx		
	20/8.00.00	
<u> </u>	·	
Legal name of second inventor	2000	
Yong Koo KIM	***************************************	
Second inventor's signature	Date	
44 Marie Carlos	10 - 10	
Shanga and the same of the sam	12018,10.10	
Legal name of third inventor		
Hyung Kyu KIM		
\	3 500	
Third inventor's signature	Date	
L QPAM	20/60, 10,10	
		
Legal name of fourth inventor	**************************************	
Won Hee YOO		
Fourth inventor's signature	Date	
	Date	
attended to the second	20/8_/0./0	
	1 100 0 1 0 1 0 1 0	
Legal name of fifth inventor		
Jong Hyun CHO		
Fifth inventor's signature	Date	
	300f. 09. A	
Legal name of sixth inventor		
Byung Kil YUN		
Sixth inventor's signature	Date	
2/ 3M1	\$ \$50.04 \$1.00 PM LG	
	2016, 10, 41	
<u> </u>		
Legal name of seventh inventor		
Seek Kyoon WOO		
Seveniti inventor's signature	3 35000	
\$ 100 miles 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	Date	
	2018.10.10	
) Acres 10 Sept. 10 10 10 10 10 10 10 10 10 10 10 10 10	
Logal name of eighth inventor		
Hyun Sung DONG		
3	T Date	
Eighth inventor's signature		
The of	2018.10.0)	
,	· ·	

Page 3 of 3

REEL: 053677 FRAME: 0258